

# ANTREX Electronics

## Electronic Components Sourcing Information

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### Product Reference Information

|                      |                           |
|----------------------|---------------------------|
| <b>Part Number:</b>  | PMZB600UNEYL              |
| <b>Manufacturer:</b> | Nexperia USA Inc.         |
| <b>Package:</b>      | Please confirm with sales |
| <b>Availability:</b> | Please confirm with sales |

**Product Page:**

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**Note:**

This PDF includes an ANTREX product reference cover page.

The original manufacturer datasheet follows from the next page.



# PMZB600UNE

20 V, N-channel Trench MOSFET

21 July 2014

Product data sheet

## 1. General description

N-channel enhancement mode Field-Effect Transistor (FET) in a leadless ultra small DFN1006B-3 (SOT883B) Surface-Mounted Device (SMD) plastic package using Trench MOSFET technology.

## 2. Features and benefits

- Trench MOSFET technology
- Leadless ultra small SMD plastic package:  $1.0 \times 0.6 \times 0.37$  mm
- ElectroStatic Discharge (ESD) protection  $> 1$  kV HBM
- Drain-source on-state resistance  $R_{DSon} = 470$  m $\Omega$

## 3. Applications

- Relay driver
- High-speed line driver
- Low-side load switch
- Switching circuits

## 4. Quick reference data

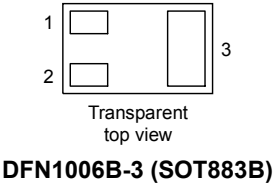
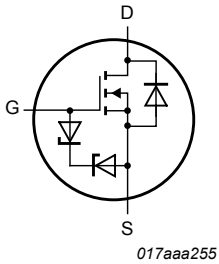
Table 1. Quick reference data

| Symbol                        | Parameter                        | Conditions                                     |     | Min | Typ | Max | Unit       |
|-------------------------------|----------------------------------|------------------------------------------------|-----|-----|-----|-----|------------|
| $V_{DS}$                      | drain-source voltage             | $T_J = 25$ °C                                  |     | -   | -   | 20  | V          |
| $V_{GS}$                      | gate-source voltage              |                                                |     | -8  | -   | 8   | V          |
| $I_D$                         | drain current                    | $V_{GS} = 4.5$ V; $T_{amb} = 25$ °C            | [1] | -   | -   | 0.6 | A          |
| <b>Static characteristics</b> |                                  |                                                |     |     |     |     |            |
| $R_{DSon}$                    | drain-source on-state resistance | $V_{GS} = 4.5$ V; $I_D = 0.6$ A; $T_J = 25$ °C |     | -   | 470 | 620 | m $\Omega$ |

[1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated, mounting pad for drain  $1$  cm<sup>2</sup>.

5. Pinning information

Table 2. Pinning information

| Pin | Symbol | Description | Simplified outline                                                                | Graphic symbol                                                                      |
|-----|--------|-------------|-----------------------------------------------------------------------------------|-------------------------------------------------------------------------------------|
| 1   | G      | gate        |  |  |
| 2   | S      | source      |                                                                                   |                                                                                     |
| 3   | D      | drain       |                                                                                   |                                                                                     |

6. Ordering information

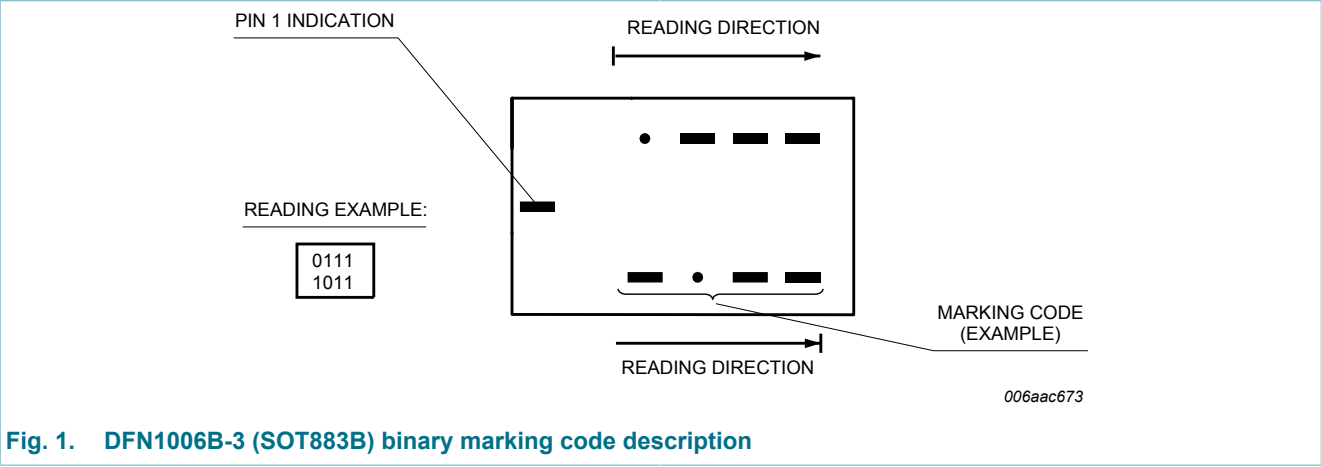
Table 3. Ordering information

| Type number | Package    |                                                                                            |         |
|-------------|------------|--------------------------------------------------------------------------------------------|---------|
|             | Name       | Description                                                                                | Version |
| PMZB600UNE  | DFN1006B-3 | DFN1006B-3: leadless ultra small plastic package; 3 solder lands; body 1.0 x 0.6 x 0.37 mm | SOT883B |

7. Marking

Table 4. Marking codes

| Type number | Marking code |
|-------------|--------------|
| PMZB600UNE  | 0101 1000    |

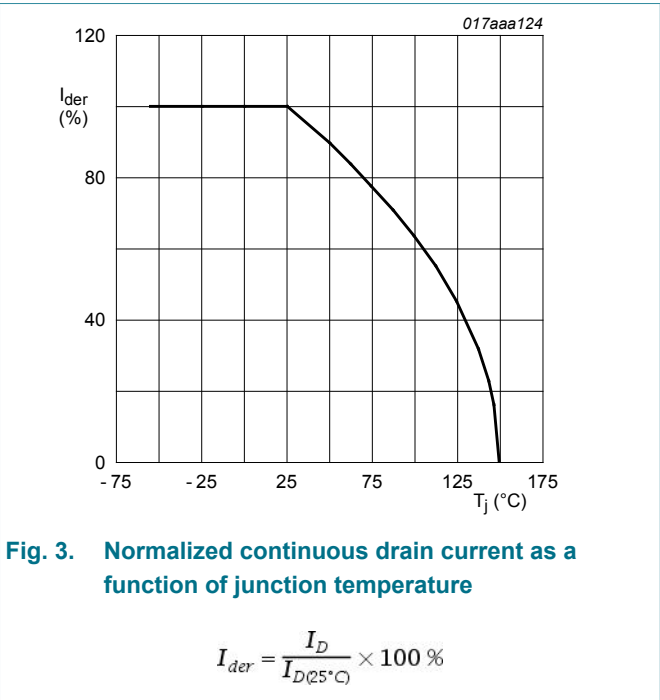
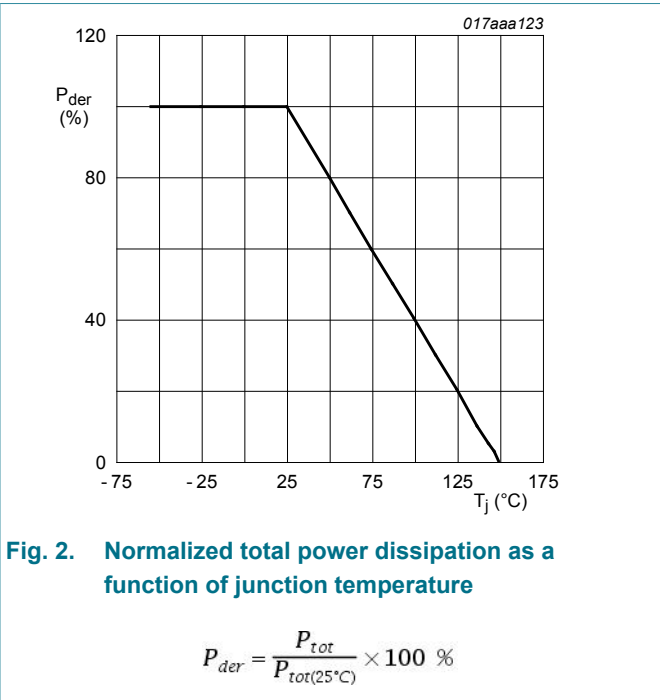


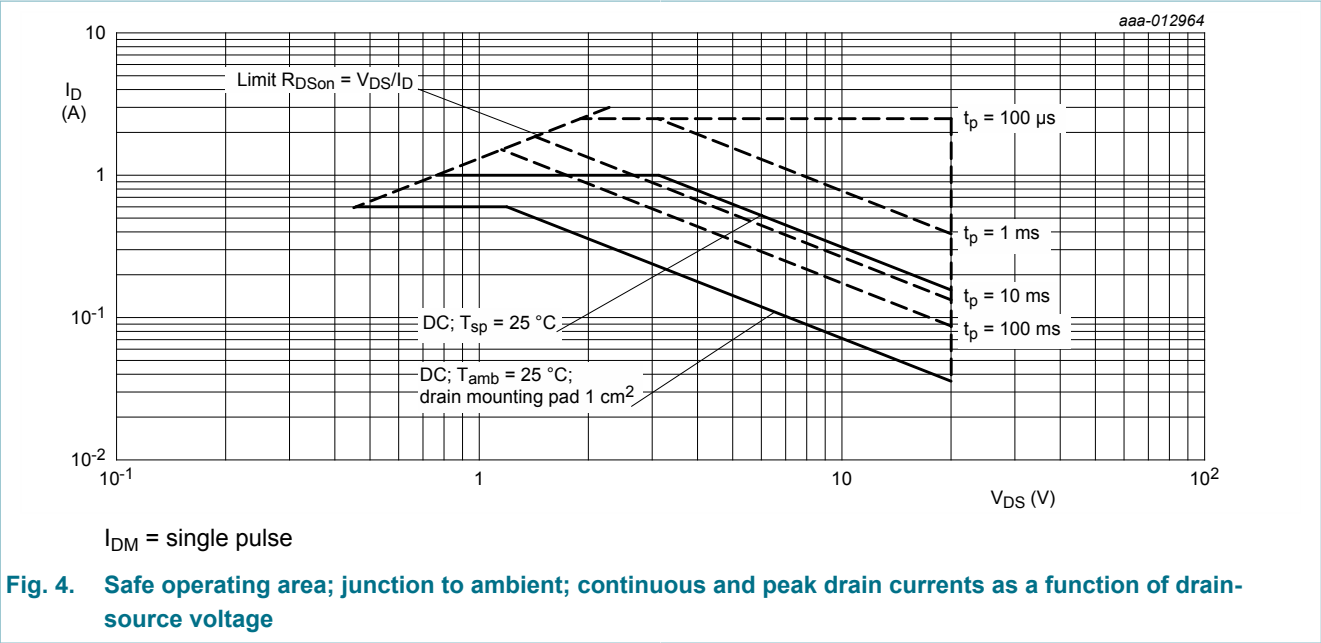
8. Limiting values

Table 5. Limiting values  
In accordance with the Absolute Maximum Rating System (IEC 60134).

| Symbol             | Parameter               | Conditions                                                     |     | Min | Max  | Unit |
|--------------------|-------------------------|----------------------------------------------------------------|-----|-----|------|------|
| V <sub>DS</sub>    | drain-source voltage    | T <sub>j</sub> = 25 °C                                         |     | -   | 20   | V    |
| V <sub>GS</sub>    | gate-source voltage     |                                                                |     | -8  | 8    | V    |
| I <sub>D</sub>     | drain current           | V <sub>GS</sub> = 4.5 V; T <sub>amb</sub> = 25 °C              | [1] | -   | 0.6  | A    |
|                    |                         | V <sub>GS</sub> = 4.5 V; T <sub>amb</sub> = 100 °C             | [1] | -   | 0.4  | A    |
| I <sub>DM</sub>    | peak drain current      | T <sub>amb</sub> = 25 °C; single pulse; t <sub>p</sub> ≤ 10 μs |     | -   | 2.5  | A    |
| P <sub>tot</sub>   | total power dissipation | T <sub>amb</sub> = 25 °C                                       | [2] | -   | 360  | mW   |
|                    |                         |                                                                | [1] | -   | 715  | mW   |
|                    |                         | T <sub>sp</sub> = 25 °C                                        |     | -   | 2700 | mW   |
| T <sub>j</sub>     | junction temperature    |                                                                |     | -55 | 150  | °C   |
| T <sub>amb</sub>   | ambient temperature     |                                                                |     | -55 | 150  | °C   |
| T <sub>stg</sub>   | storage temperature     |                                                                |     | -65 | 150  | °C   |
| Source-drain diode |                         |                                                                |     |     |      |      |
| I <sub>S</sub>     | source current          | T <sub>amb</sub> = 25 °C                                       | [1] | -   | 0.4  | A    |

- [1] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated, mounting pad for drain 1 cm<sup>2</sup>.
- [2] Device mounted on an FR4 Printed-Circuit Board (PCB), single-sided copper, tin-plated and standard footprint.



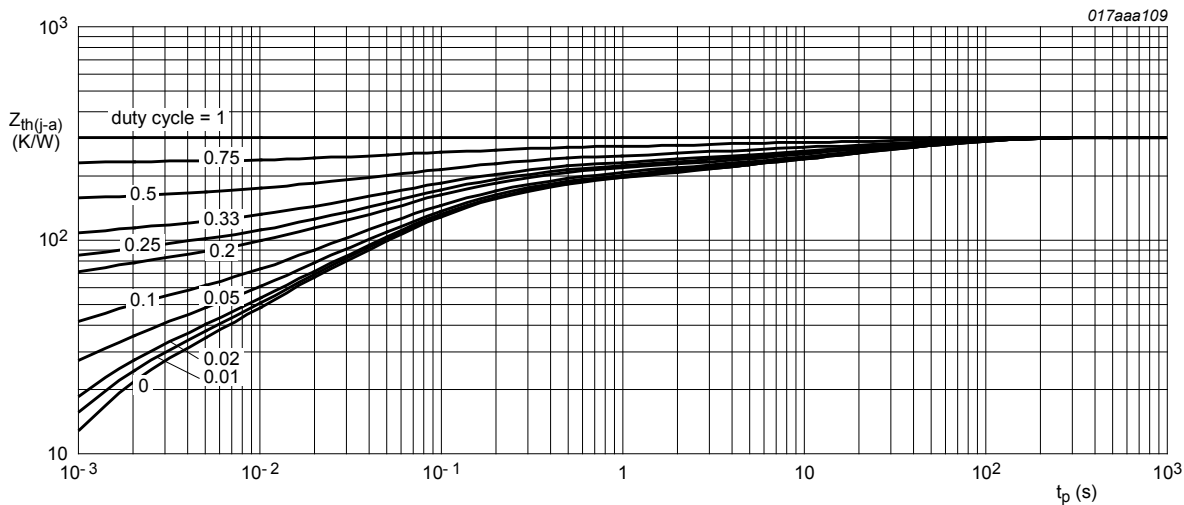


9. Thermal characteristics

Table 6. Thermal characteristics

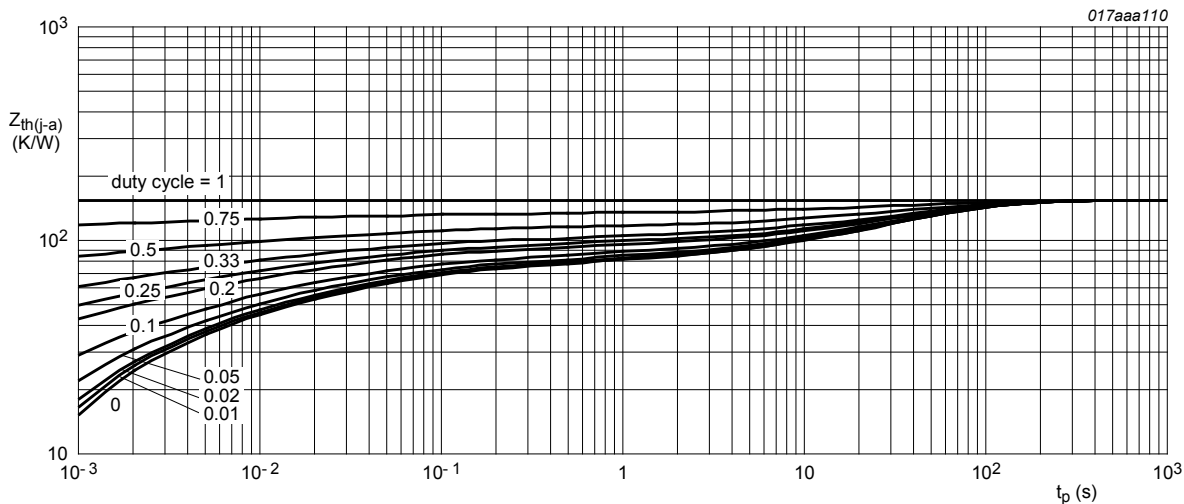
| Symbol         | Parameter                                        | Conditions  |     | Min | Typ | Max | Unit |
|----------------|--------------------------------------------------|-------------|-----|-----|-----|-----|------|
| $R_{th(j-a)}$  | thermal resistance from junction to ambient      | in free air | [1] | -   | 305 | 360 | K/W  |
|                |                                                  |             | [2] | -   | 150 | 175 | K/W  |
| $R_{th(j-sp)}$ | thermal resistance from junction to solder point |             |     | -   | -   | 40  | K/W  |

[1] Device mounted on an FR4 PCB, single-sided copper, tin-plated and standard footprint.  
[2] Device mounted on an FR4 PCB, single-sided copper, tin-plated, mounting pad for drain  $1\text{ cm}^2$ .



FR4 PCB, standard footprint

Fig. 5. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values



FR4 PCB, mounting pad for drain 1 cm<sup>2</sup>

Fig. 6. Transient thermal impedance from junction to ambient as a function of pulse duration; typical values

## 10. Characteristics

Table 7. Characteristics

| Symbol                         | Parameter                        | Conditions                                                                                              | Min  | Typ  | Max  | Unit       |
|--------------------------------|----------------------------------|---------------------------------------------------------------------------------------------------------|------|------|------|------------|
| <b>Static characteristics</b>  |                                  |                                                                                                         |      |      |      |            |
| $V_{(BR)DSS}$                  | drain-source breakdown voltage   | $I_D = 250\ \mu A$ ; $V_{GS} = 0\ V$ ; $T_j = 25\ ^\circ C$                                             | 20   | -    | -    | V          |
| $V_{GSth}$                     | gate-source threshold voltage    | $I_D = 250\ \mu A$ ; $V_{DS} = V_{GS}$ ; $T_j = 25\ ^\circ C$                                           | 0.45 | 0.7  | 0.95 | V          |
| $I_{DSS}$                      | drain leakage current            | $V_{DS} = 20\ V$ ; $V_{GS} = 0\ V$ ; $T_j = 25\ ^\circ C$                                               | -    | -    | 1    | $\mu A$    |
|                                |                                  | $V_{DS} = 20\ V$ ; $V_{GS} = 0\ V$ ; $T_j = 150\ ^\circ C$                                              | -    | -    | 10   | $\mu A$    |
| $I_{GSS}$                      | gate leakage current             | $V_{GS} = 8\ V$ ; $V_{DS} = 0\ V$ ; $T_j = 25\ ^\circ C$                                                | -    | -    | 10   | $\mu A$    |
|                                |                                  | $V_{GS} = -8\ V$ ; $V_{DS} = 0\ V$ ; $T_j = 25\ ^\circ C$                                               | -    | -    | -10  | $\mu A$    |
|                                |                                  | $V_{GS} = 4.5\ V$ ; $V_{DS} = 0\ V$ ; $T_j = 25\ ^\circ C$                                              | -    | -    | 1    | $\mu A$    |
|                                |                                  | $V_{GS} = -4.5\ V$ ; $V_{DS} = 0\ V$ ; $T_j = 25\ ^\circ C$                                             | -    | -    | -1   | $\mu A$    |
| $R_{DSon}$                     | drain-source on-state resistance | $V_{GS} = 4.5\ V$ ; $I_D = 0.6\ A$ ; $T_j = 25\ ^\circ C$                                               | -    | 470  | 620  | m $\Omega$ |
|                                |                                  | $V_{GS} = 4.5\ V$ ; $I_D = 0.6\ A$ ; $T_j = 150\ ^\circ C$                                              | -    | 760  | 1000 | m $\Omega$ |
|                                |                                  | $V_{GS} = 2.5\ V$ ; $I_D = 0.5\ A$ ; $T_j = 25\ ^\circ C$                                               | -    | 620  | 850  | m $\Omega$ |
|                                |                                  | $V_{GS} = 1.8\ V$ ; $I_D = 0.1\ A$ ; $T_j = 25\ ^\circ C$                                               | -    | 845  | 1300 | m $\Omega$ |
|                                |                                  | $V_{GS} = 1.5\ V$ ; $I_D = 10\ mA$ ; $T_j = 25\ ^\circ C$                                               | -    | 1125 | 3000 | m $\Omega$ |
|                                |                                  | $V_{GS} = 1.2\ V$ ; $I_D = 1\ mA$ ; $T_j = 25\ ^\circ C$                                                | -    | 2210 | -    | m $\Omega$ |
| $g_{fs}$                       | forward transconductance         | $V_{DS} = 5\ V$ ; $I_D = 0.6\ A$ ; $T_j = 25\ ^\circ C$                                                 | -    | 1    | -    | S          |
| $R_G$                          | gate resistance                  | $f = 1\ MHz$                                                                                            | -    | 34   | -    | $\Omega$   |
| <b>Dynamic characteristics</b> |                                  |                                                                                                         |      |      |      |            |
| $Q_{G(tot)}$                   | total gate charge                | $V_{DS} = 10\ V$ ; $I_D = 0.6\ A$ ; $V_{GS} = 4.5\ V$ ; $T_j = 25\ ^\circ C$                            | -    | 0.4  | 0.7  | nC         |
| $Q_{GS}$                       | gate-source charge               |                                                                                                         | -    | 0.1  | -    | nC         |
| $Q_{GD}$                       | gate-drain charge                |                                                                                                         | -    | 0.1  | -    | nC         |
| $C_{iss}$                      | input capacitance                | $V_{DS} = 10\ V$ ; $f = 1\ MHz$ ; $V_{GS} = 0\ V$ ; $T_j = 25\ ^\circ C$                                | -    | 21.3 | -    | pF         |
| $C_{oss}$                      | output capacitance               |                                                                                                         | -    | 5.4  | -    | pF         |
| $C_{rss}$                      | reverse transfer capacitance     |                                                                                                         | -    | 4.2  | -    | pF         |
| $t_{d(on)}$                    | turn-on delay time               | $V_{DS} = 10\ V$ ; $I_D = 0.6\ A$ ; $V_{GS} = 4.5\ V$ ; $R_{G(ext)} = 6\ \Omega$ ; $T_j = 25\ ^\circ C$ | -    | 5.6  | -    | ns         |
| $t_r$                          | rise time                        |                                                                                                         | -    | 9.2  | -    | ns         |
| $t_{d(off)}$                   | turn-off delay time              |                                                                                                         | -    | 19   | -    | ns         |
| $t_f$                          | fall time                        |                                                                                                         | -    | 51   | -    | ns         |

| Symbol             | Parameter            | Conditions                                                                         | Min | Typ | Max | Unit |
|--------------------|----------------------|------------------------------------------------------------------------------------|-----|-----|-----|------|
| Source-drain diode |                      |                                                                                    |     |     |     |      |
| $V_{SD}$           | source-drain voltage | $I_S = 0.36\text{ A}$ ; $V_{GS} = 0\text{ V}$ ; $T_j = 25\text{ }^{\circ}\text{C}$ | -   | 0.8 | 1.2 | V    |

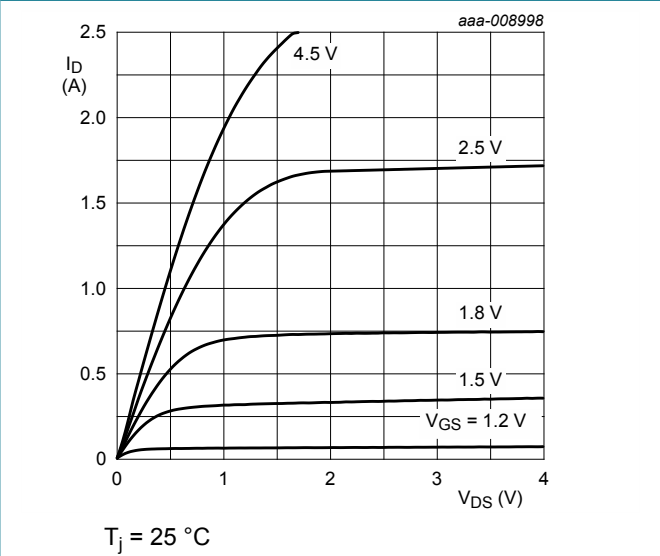


Fig. 7. Output characteristics: drain current as a function of drain-source voltage; typical values

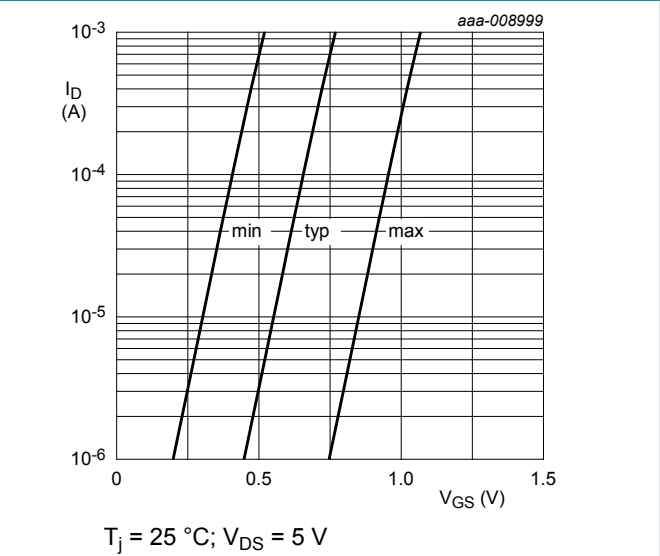


Fig. 8. Sub-threshold drain current as a function of gate-source voltage

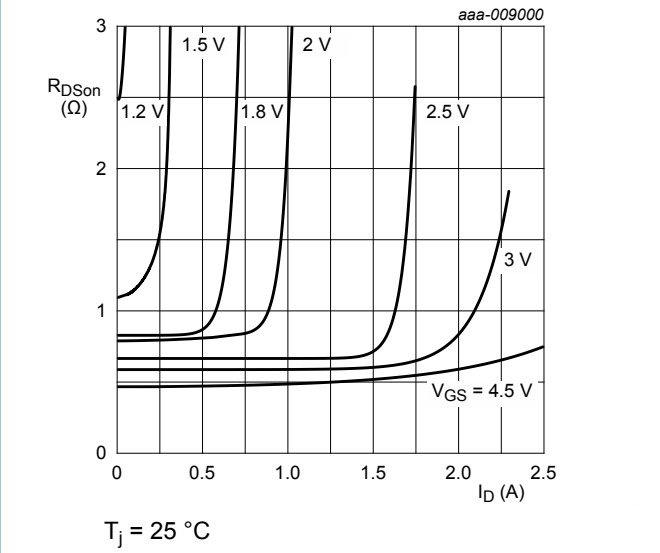


Fig. 9. Drain-source on-state resistance as a function of drain current; typical values

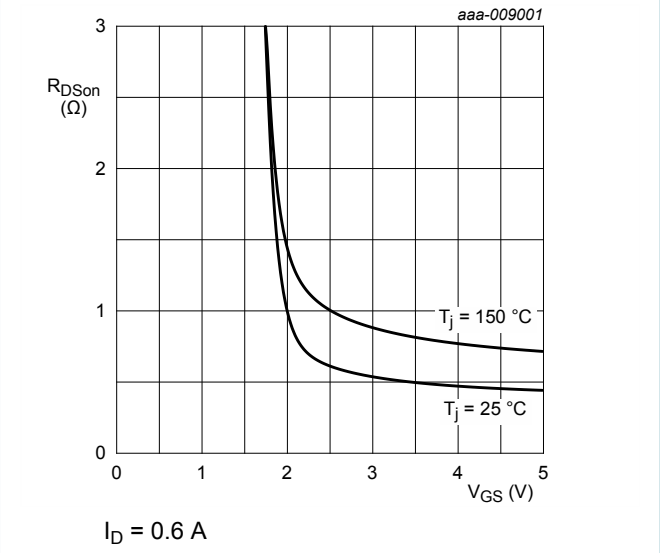


Fig. 10. Drain-source on-state resistance as a function of gate-source voltage; typical values

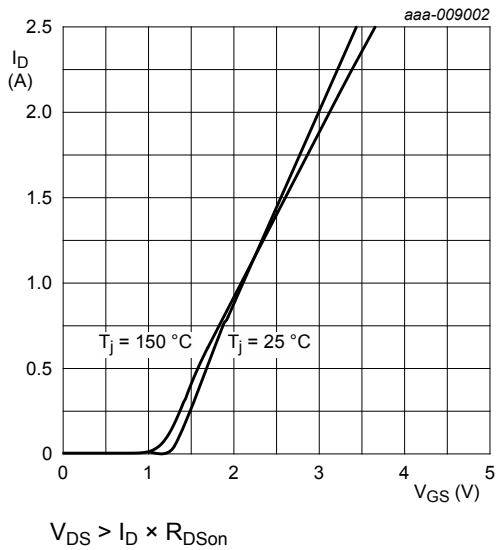


Fig. 11. Transfer characteristics: drain current as a function of gate-source voltage; typical values

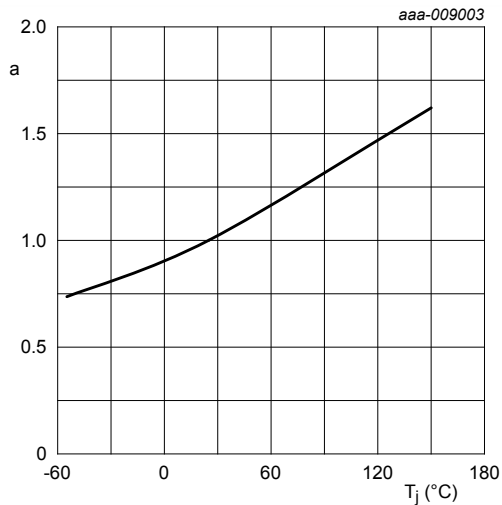


Fig. 12. Normalized drain-source on-state resistance as a function of junction temperature; typical values

$$a = \frac{R_{DSon}}{R_{DSon(25\text{ °C})}}$$

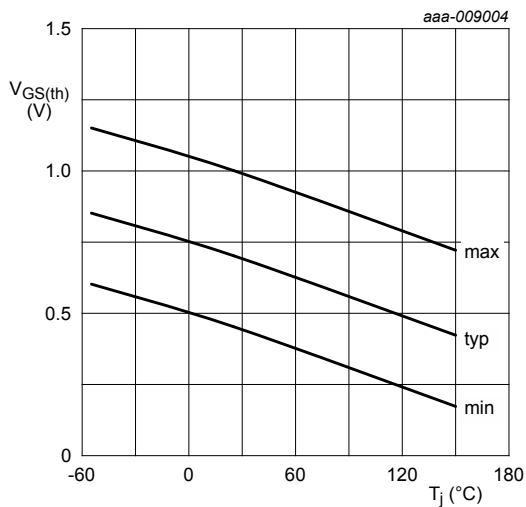


Fig. 13. Gate-source threshold voltage as a function of junction temperature

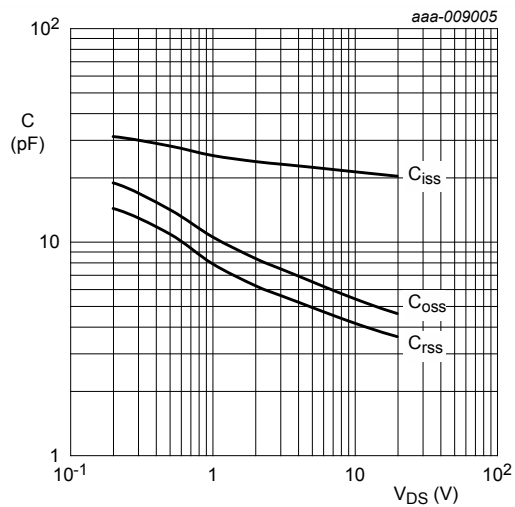


Fig. 14. Input, output and reverse transfer capacitances as a function of drain-source voltage; typical values

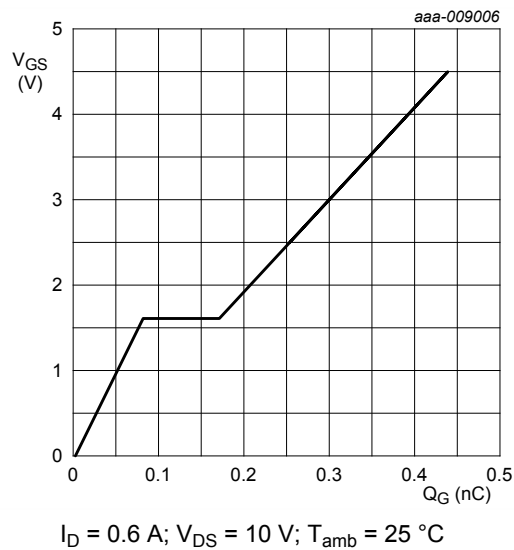


Fig. 15. Gate-source voltage as a function of gate charge; typical values

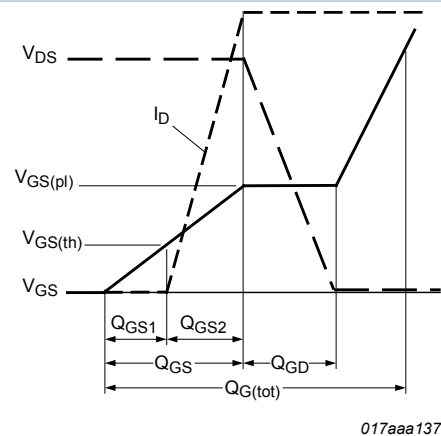


Fig. 16. MOSFET transistor: Gate charge waveform definitions

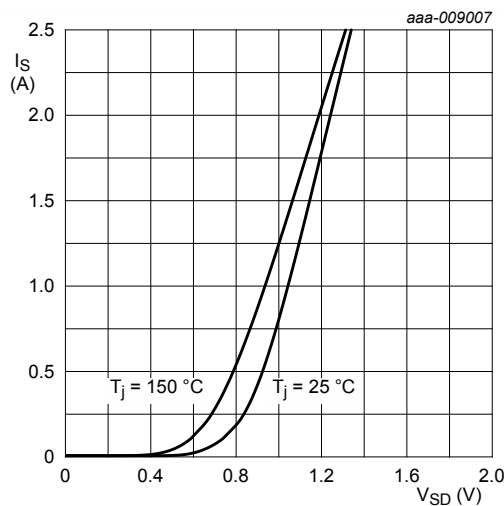


Fig. 17. Source current as a function of source-drain voltage; typical values

## 11. Test information

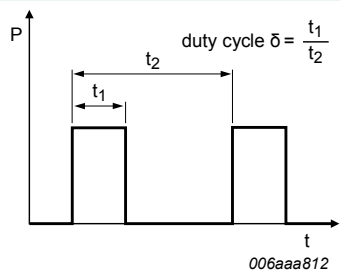
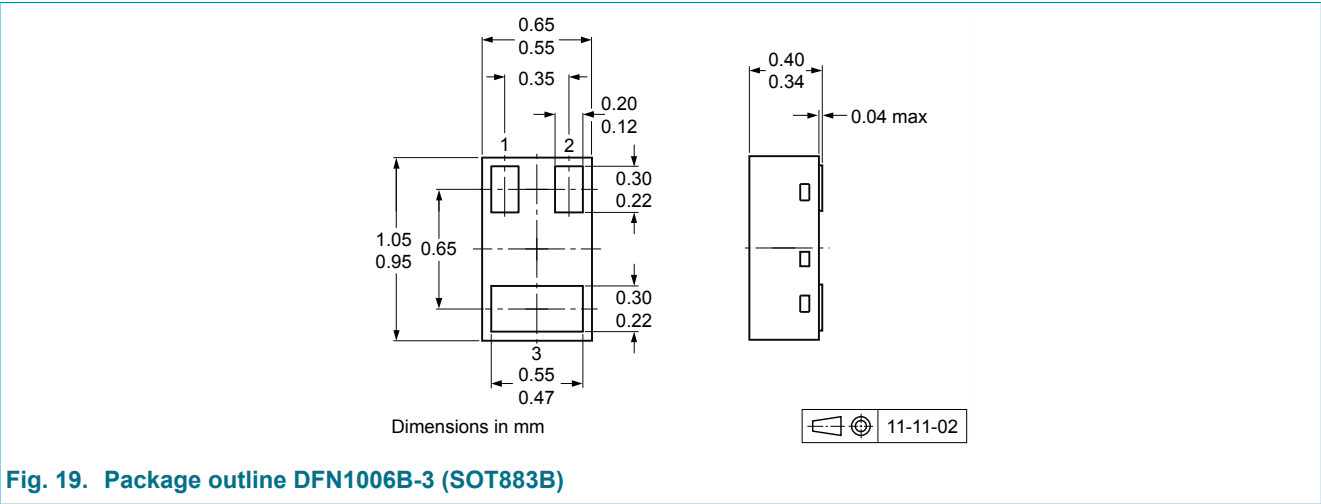
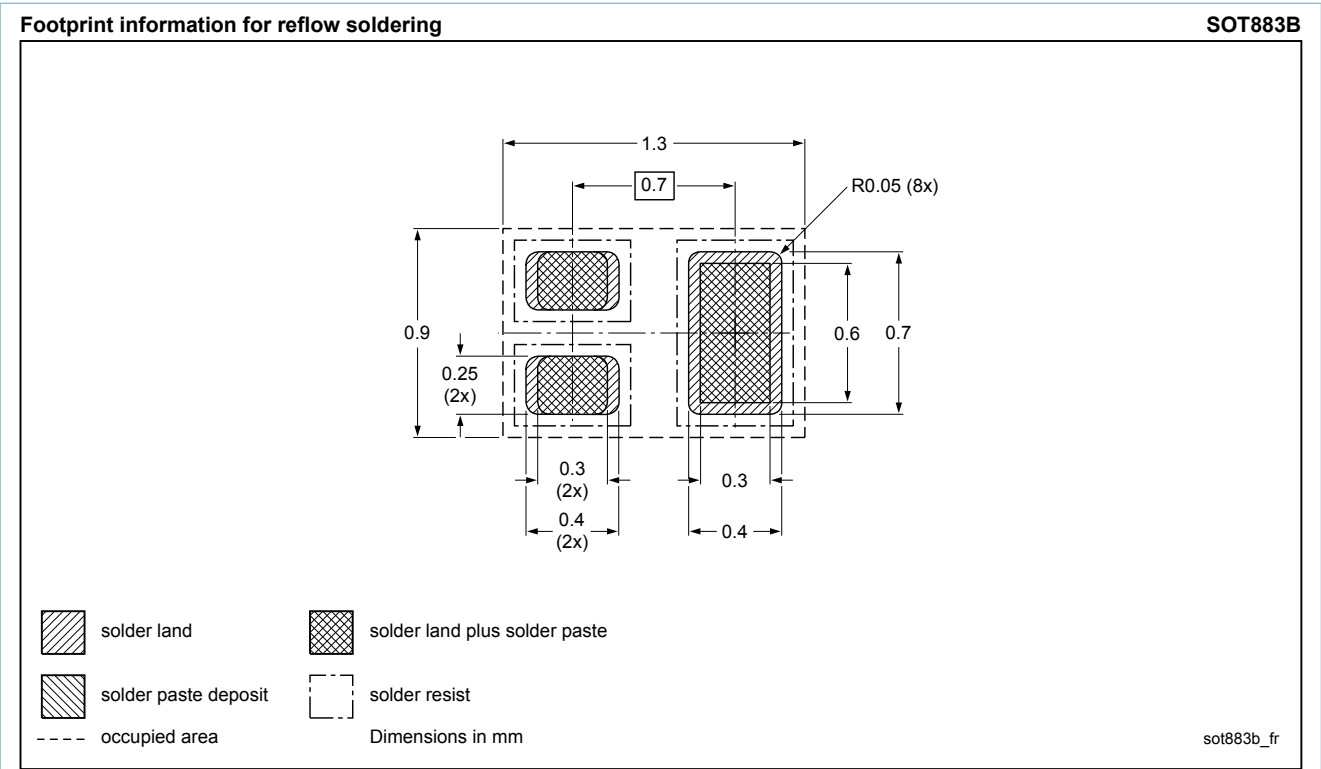


Fig. 18. Duty cycle definition

12. Package outline



13. Soldering



## 14. Revision history

Table 8. Revision history

| Data sheet ID  | Release date | Data sheet status  | Change notice | Supersedes |
|----------------|--------------|--------------------|---------------|------------|
| PMZB600UNE v.1 | 20140721     | Product data sheet | -             | -          |

## 15. Legal information

### 15.1 Data sheet status

| Document status [1][2]         | Product status [3] | Definition                                                                            |
|--------------------------------|--------------------|---------------------------------------------------------------------------------------|
| Objective [short] data sheet   | Development        | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification      | This document contains data from the preliminary specification.                       |
| Product [short] data sheet     | Production         | This document contains the product specification.                                     |

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions".
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL <http://www.nexperia.com>.

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